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September 2013

J105 / J106 / J107 N-Channel Switch

Description

This device is designed for analog or digital switching applications where very low on resistance is mandatory. Sourced from Process 59.



Ordering Informations

Part Number	Marking	Package	Packing Method	
J105	J105			
J106	J106	TO-92 3L	Bulk	
J107	J107			

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Units
V_{DG}	Drain-Gate Voltage	25	V
V _{GS}	Gate-Source Voltage	-25	V
I_{GF}	Forward Gate Current	10	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Notes:

1. These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

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- 2. These ratings are based on a maximum junction temperature of 150°C.
- 3. These are steady-state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics(4)

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Maximum	Units
P _D	Power Dissipation	625	mW
	Derate above 25°C	5.0	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

Note:

4. PCB board size FR-4 76 x 114 x 0.6T mm³ (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	;	Min	Max	Units	
OFF CHA	RACTERISTICS					,-I	
V _{(BR)GSS}	Gate-Source Breakdown Voltage	I _G = -10 μA, V _{DS} = 0		-25		V	
I _{GSS}	Gate Reverse Current	$V_{GS} = -15 \text{ V}, V_{DS} = 0$			-3.0	nA	
	Cate Reverse Current	V _{GS} = -15 V, V _{DS} = 0, T _A = 100°C			-200		
I _{D(off)}	Gate-Source Cut-Off Voltage	V_{DS} = -5.0 V, V_{GS} = -10 V			3.0	nA	
	Gate-Source Cut-Off Voltage	V _{DS} = 5.0 V, I _D = 1.0 mA	J105	-4.5	-10.0	V	
			J106	-2.0	-6.0		
			J107	-0.5	-4.5		
ON CHAR	ACTERISTICS	•	<u> </u>		1		
	Zero-Gate Voltage Drain Current ⁽⁵⁾	V _{DS} = 15 V, I _{GS} = 0	J105	500		mA	
			J106	200			
			J107	100			
R _{DS(on)}	Drain-Source On Resistance	$V_{DS} \le 0.1 \text{ V, } V_{GS} = 0$	J105		3.0	Ω	
			J106		6.0		
			J107		8.0		
SMALL SI	GNAL CHARACTERISTICS	1			II.		
C _{dg(on)}	Drain-Gate On Capacitance	V _{DS} = 0, V _{GS} = 10 V, f = 1.0 MHz		100			
C _{sg(on)}	Source-Gate On Capacitance			160	pF		
C _{dg(off)}	Drain-Gate Off Capacitance			25	pF		
C _{sg(off)}	Source-Gate Off Capacitance			35	pF		

Note:

5. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2.0%.

Typical Performance Characteristic

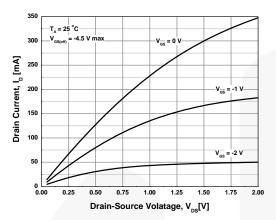


Figure 1. Common Drain-Source Characteristics

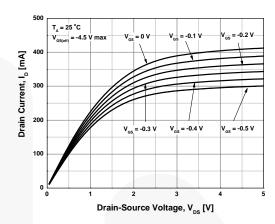


Figure 2. Common Drain-Source Characteristics

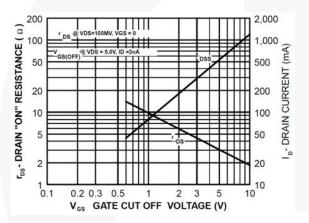


Figure 3. Parameter Interactions

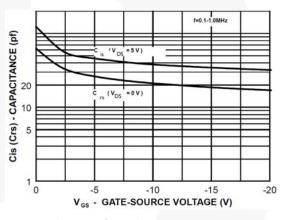


Figure 4. Capacitance vs. Voltage

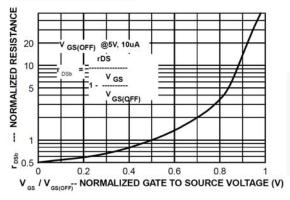


Figure 5. Normalized Drain Resistance vs. Bias Voltage

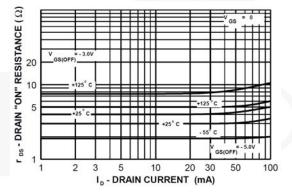


Figure 6. On Resistance vs. Drain Current

Typical Performance Characteristic (Continued)

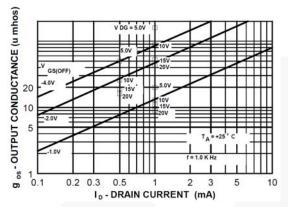


Figure 7. Output Conductance vs. Drain Current

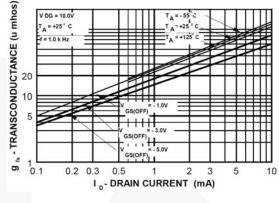


Figure 8. Transconductance vs. Drain Current

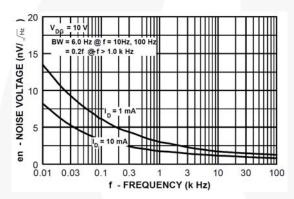


Figure 9. Noise Voltage vs. Frequency

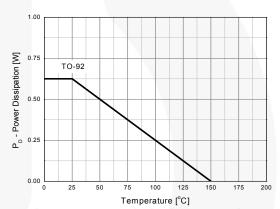


Figure 10. Power Dissipation vs. Ambient Temperature

Physical Dimensions

TO-92

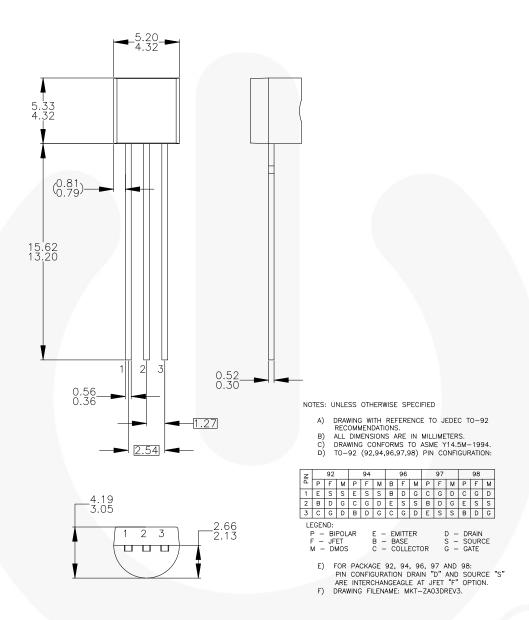


Figure 11. 3-LEAD, TO-92, MOLDED, STD STRAIGHT LD (NO EOL CODE)

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Definition of Terms			
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
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